Appl. No. 10/552,950; Docket No. NL03 0391 US Amdt. dated May 1, 2007 Response to Office Action dated April 17, 2007

REMARKS/ARGUMENTS

Claims 1-10 are pending.

In response to Examiner's calling for restriction, Applicant elects Group A, claims 1-8 and 10, directed to a method of determining a dielectric layer thickness, class 438, subclass 11

Please cancel claim 9 without prejudice.

The Commissioner is hereby requested and authorized pursuant to 37 CFR §1.136(a)(3), to treat any concurrent or future reply in this application requiring a petition for extension of time for its timely submission, as incorporating a petition for extension of time for the appropriate length of time. Please charge any additional fees which may now or in the future be required in this application, including extension of time fees, but excluding the issue fee unless explicitly requested to do so, and credit any overpayment, to Deposit Account No. 50-4019.

Respectfully submitted.

Date: May 1, 2007 By /Peter Zawilsk/

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CUSTOMER NUMBER: 65913